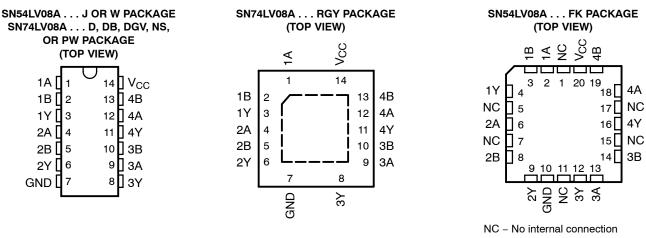
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- 2-V to 5.5-V V_{CC} Operation
- Max t_{pd} of 7 ns at 5 V
- Typical V_{OLP} (Output Ground Bounce) <0.8 V at V_{CC} = 3.3 V, $T_A = 25^{\circ}C$
- Typical V_{OHV} (Output V_{OH} Undershoot)
 >2.3 V at V_{CC} = 3.3 V, T_A = 25°C
- Support Mixed-Mode Voltage Operation on All Ports
- I_{off} Supports Partial-Power-Down Mode Operation
- Latch-Up Performance Exceeds 250 mA Per JESD 17
- ESD Protection Exceeds JESD 22
 - 2000-V Human-Body Model (A114-A)
 - 200-V Machine Model (A115-A)
 - 1000-V Charged-Device Model (C101)



description/ordering information

These quadruple 2-input positive-AND gates are designed for 2-V to 5.5-V V_{CC} operation. The 'LV08A devices perform the Boolean function $Y = A \bullet B$ or $Y = \overline{\overline{A} + \overline{B}}$ in positive logic.

These devices are fully specified for partial-power-down applications using I_{off}. The I_{off} circuitry disables the outputs, preventing damaging current backflow through the devices when they are powered down.

T _A	PACK	AGE [†]	ORDERABLE PART NUMBER	TOP-SIDE MARKING			
	QFN – RGY	Reel of 1000	SN74LV08ARGYR	LV08A			
		Tube of 50	SN74LV08AD	11/004			
	SOIC – D	Reel of 2500	SN74LV08ADR	LV08A			
	SOP – NS	Reel of 2000	SN74LV08ANSR	74LV08A			
–40°C to 85°C	SSOP – DB	Reel of 2000	SN74LV08ADBR	LV08A			
		Tube of 90	SN74LV08APW				
	TSSOP – PW	Reel of 2000	SN74LV08APWRG3	LV08A			
		Reel of 250	SN74LV08APWT				
	TVSOP – DGV	Reel of 2000	SN74LV08ADGVR	LV08A			
	CDIP – J	Tube of 25	SNJ54LV08AJ	SNJ54LV08AJ			
–55°C to 125°C	CFP – W	Tube of 150	SNJ54LV08AW	SNJ54LV08AW			
	LCCC – FK	Tube of 55	SNJ54LV08AFK	SNJ54LV08AFK			

ORDERING INFORMATION

[†] Package drawings, standard packing quantities, thermal data, symbolization, and PCB design guidelines are available at www.ti.com/sc/package.



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FUNCTION TABLE (each gate)					
INP	JTS	OUTPUT			
Α	В	Y			
Н	Н	Н			
L	Х	L			
Х	L	L			

logic diagram, each gate (positive logic)



absolute maximum ratings over operating free-air temperature range (unless otherwise noted)[†]

Supply voltage range, V_{CC}	
Input voltage range, VI (see Note 1)–0.5 V to 7	V
Voltage range applied to any output in the high-impedance	
or power-off state, V _O (see Note 1)0.5 V to 7	V
Output voltage range, V ₀ (see Notes 1 and 2)0.5 V to V _{CC} + 0.5	V
Input clamp current, I _{IK} (V _I < 0)	
Output clamp current, I _{OK} (V _O < 0)	۱A
Continuous output current, I _O (V _O = 0 to V _{CC}) ±25 m	۱A
Continuous current through V _{CC} or GND ±50 m	۱A
Package thermal impedance, θ _{JA} (see Note 3): D package	W
(see Note 3): DB package	W
(see Note 3): DGV package	W
(see Note 3): NS package	W
(see Note 3): PW package	W
(see Note 4): RGY package	W
Storage temperature range, T _{stg} 65°C to 150°	,C

[†] Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

- NOTES: 1. The input and output negative-voltage ratings may be exceeded if the input and output current ratings are observed. 2. This value is limited to 5.5 V maximum.

 - 3. The package thermal impedance is calculated in accordance with JESD 51-7.
 - 4. The package thermal impedance is calculated in accordance with JESD 51-5.



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			SN54L	_V08A	SN74L	V08A	
			MIN	MAX	MIN	MAX	UNIT
V_{CC}	Supply voltage		2	5.5	2	5.5	V
		V _{CC} = 2 V	1.5		1.5		
		V_{CC} = 2.3 V to 2.7 V	$V_{CC} imes 0.7$		$V_{CC} imes 0.7$		
VIH	High-level input voltage	V _{CC} = 3 V to 3.6 V	$V_{CC} \times 0.7$		$V_{CC} imes 0.7$		V
		V_{CC} = 4.5 V to 5.5 V	$V_{CC} \times 0.7$		$V_{CC} imes 0.7$		
		V _{CC} = 2 V		0.5		0.5	
.,		V_{CC} = 2.3 V to 2.7 V		$V_{CC} imes 0.3$		$V_{CC}\!\times\!0.3$	
V _{IL}	Low-level input voltage	V _{CC} = 3 V to 3.6 V		$V_{CC} imes 0.3$		$V_{CC}\!\times\!0.3$	V
		V_{CC} = 4.5 V to 5.5 V		$V_{CC} \times 0.3$		$V_{CC}\!\times\!0.3$	
VI	Input voltage		0	5.5	0	5.5	V
Vo	Output voltage		0	✓ V _{CC}	0	V _{CC}	V
		V _{CC} = 2 V	S	-50		-50	μA
		V_{CC} = 2.3 V to 2.7 V	00	-2		-2	
I _{OH}	High-level output current	V _{CC} = 3 V to 3.6 V	A A	-6		-6	mA
		V_{CC} = 4.5 V to 5.5 V		-12		-12	
		V _{CC} = 2 V		50		50	μA
		V_{CC} = 2.3 V to 2.7 V		2		2	
I _{OL}	Low-level output current	V _{CC} = 3 V to 3.6 V		6		6	mA
		V_{CC} = 4.5 V to 5.5 V		12		12	
		V_{CC} = 2.3 V to 2.7 V		200		200	
Δt/Δv	Input transition rise or fall rate	V _{CC} = 3 V to 3.6 V		100		100	ns/V
		V_{CC} = 4.5 V to 5.5 V		20		20	
T _A	Operating free-air temperature		-55	125	-40	85	°C

recommended operating conditions (see Note 5)

NOTE 5: All unused inputs of the device must be held at V_{CC} or GND to ensure proper device operation. Refer to the TI application report, *Implications of Slow or Floating CMOS Inputs*, literature number SCBA004.

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

			SN5	4LV08A	SN7	4LV08A	
PARAMETER	TEST CONDITIONS	V _{cc}	MIN	ΤΥΡ ΜΑλ	(MIN	TYP MAX	UNIT
	I _{OH} = -50 μA	2 V to 5.5 V	V _{CC} -0.1		V _{CC} -0.1		
N/	$I_{OH} = -2 \text{ mA}$	2.3 V	2		2		v
V _{OH}	I _{OH} = -6 mA	3 V	2.48		2.48		v
	I _{OH} = -12 mA	4.5 V	3.8	M	3.8		
	I _{OL} = 50 μA	2 V to 5.5 V		0.		0.1	
N/	I _{OL} = 2 mA	2.3 V		Q 0.4	1	0.4	v
V _{OL}	I _{OL} = 6 mA	3 V	ć	0.4	1	0.44	v
	I _{OL} = 12 mA	4.5 V	ng	0.5	5	0.55	
I _I	$V_{I} = 5.5 V \text{ or GND}$	0 to 5.5 V	04	Ŧ		±1	μA
I _{CC}	$V_{I} = V_{CC}$ or GND, $I_{O} = 0$	5.5 V	Q	20)	20	μA
I _{off}	V_{I} or V_{O} = 0 to 5.5 V	0		Į	5	5	μA
C _i	V _I = V _{CC} or GND	3.3 V		3.3		3.3	pF
Ui		5 V		3.3		3.3	ΡF

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switching characteristics over recommended operating free-air temperature range, V_{CC} = 2.5 V \pm 0.2 V (unless otherwise noted) (see Figure 1)

DADAMETED	FROM	то	LOAD	T,	₄ = 25°C	;	SN54LV08A	SN74L	V08A	
PARAMETER	(INPUT)	(OUTPUT)	CAPACITANCE	MIN	TYP	MAX	MIN	MIN	MAX	UNIT
+ .	A or B	V	C _L = 15 pF		7.9*	13.8*	1* 17*	1	16	
^t pd	AULP	ſ	C _L = 50 pF		10.5	17.3	2 1 21	1	20	ns

* On products compliant to MIL-PRF-38535, this parameter is not production tested.

switching characteristics over recommended operating free-air temperature range, V_{CC} = 3.3 V \pm 0.3 V (unless otherwise noted) (see Figure 1)

DADAMETER	FROM	то	LOAD	T	_A = 25°C	;	SN54LV08A	SN74L	V08A	
PARAMETER	(INPUT)	(OUTPUT)	CAPACITANCE	MIN	TYP	MAX	MIN MAX	MIN	MAX	UNIT
+ .	A or B	v	C _L = 15 pF		5.6*	8.8*	1 * 11.5*	1	10.5	
Lpd	AOIB	Ť	C _L = 50 pF		7.5	12.3	15	1	14	ns

* On products compliant to MIL-PRF-38535, this parameter is not production tested.

switching characteristics over recommended operating free-air temperature range, V_{CC} = 5 V \pm 0.5 V (unless otherwise noted) (see Figure 1)

DADAMETER	FROM	то	LOAD	T,	_A = 25°C	;	SN54LV08A	SN74L	V08A	
PARAMETER	(INPUT)	(OUTPUT)	CAPACITANCE	MIN	TYP	MAX	MIN MAX	MIN	MAX	UNIT
+ .	A or B	v	C _L = 15 pF		4.1*	5.9*	1 * 8*	1	7	
^L pd	AUB	T	C _L = 50 pF		5.5	7.9	1 0	1	9	ns

* On products compliant to MIL-PRF-38535, this parameter is not production tested.

noise characteristics, V_{CC} = 3.3 V, C_L = 50 pF, T_A = 25°C (see Note 6)

		SN	74LV08	Α	
	PARAMETER				UNIT
V _{OL(P)}	Quiet output, maximum dynamic V _{OL}		0.2	0.8	V
V _{OL(V)}	Quiet output, minimum dynamic V _{OL}		-0.1	-0.8	V
V _{OH(V)}	Quiet output, minimum dynamic V _{OH}		3.1		V
V _{IH(D)}	High-level dynamic input voltage	2.31			V
V _{IL(D)}	Low-level dynamic input voltage			0.99	V

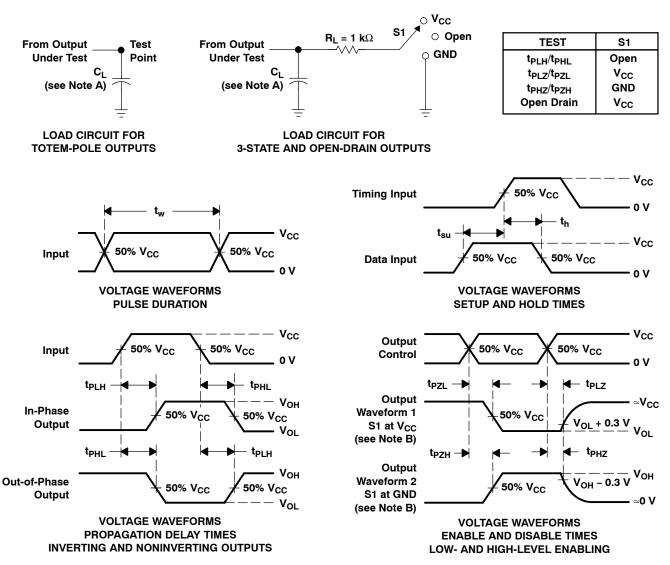
NOTE 6: Characteristics are for surface-mount packages only.

operating characteristics, $T_A = 25^{\circ}C$

	PARAMETER		TEST CO	V _{CC}	TYP	UNIT	
ſ	<u> </u>	Dever dissinction conscitutes	С <u>50</u> рГ	f = 10 MHz	3.3 V	8	۶G
	Cpd	Power dissipation capacitance	C _L = 50 pF,		5 V	10	рг



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PARAMETER MEASUREMENT INFORMATION

NOTES: A. C_L includes probe and jig capacitance.

- B. Waveform 1 is for an output with internal conditions such that the output is low, except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high, except when disabled by the output control.
- C. All input pulses are supplied by generators having the following characteristics: PRR \leq 1 MHz, Z₀ = 50 Ω , t_r \leq 3 ns, t_f \leq 3 ns.
- D. The outputs are measured one at a time, with one input transition per measurement.
- E. t_{PLZ} and t_{PHZ} are the same as t_{dis}.
- F. t_{PZL} and t_{PZH} are the same as t_{en} .
- G. t_{PHL} and t_{PLH} are the same as t_{pd} .
- H. All parameters and waveforms are not applicable to all devices.

Figure 1. Load Circuit and Voltage Waveforms



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